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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c715t-04i-ss

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture in which program and data are fetched from the same memory using the same bus. Separating program and data buses further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions (35) execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The table below lists program memory (EPROM) and data memory (RAM) for each PIC16C71X device.

Device	Program Memory	Data Memory
PIC16C710	512 x 14	36 x 8
PIC16C71	1K x 14	36 x 8
PIC16C711	1K x 14	68 x 8
PIC16C715	2K x 14	128 x 8

The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers, including the program counter, are mapped in the data memory. The PIC16CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16CXX simple yet efficient. In addition, the learning curve is reduced significantly.

PIC16CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between the data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow bit and a digit borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 3-1: PIC16C71X BLOCK DIAGRAM



4.2.2.2 OPTION REGISTER

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The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the External INT Interrupt, TMR0, and the weak pull-ups on PORTB.

FIGURE 4-8: OPTION REGISTER (ADDRESS 81h, 181h)

R/W-1	R/W-1	R/W-1 F	R/W-1 R/W-1	R/W-1	R/W-1	R/W-1						
RBPU bit7	INTEDG	TOCS	TOSE PSA	PS2	PS1	PS0 bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset					
bit 7:	RBPU: PO 1 = PORTE 0 = PORTE	RTB Pull-up 3 pull-ups ai 3 pull-ups ai	o Enable bit re disabled re enabled by inc	lividual port	latch value	es						
bit 6:	INTEDG: Interrupt Edge Select bit 1 = Interrupt on rising edge of RB0/INT pin 0 = Interrupt on falling edge of RB0/INT pin											
bit 5:	TOCS: TMF 1 = Transiti 0 = Interna	R0 Clock Sc on on RA4/ I instruction	ource Select bit T0CKI pin cycle clock (CLł	(OUT)								
bit 4:	TOSE: TMF 1 = Increm 0 = Increm	R0 Source E ent on high- ent on low-t	Edge Select bit to-low transition o-high transition	on RA4/T0 on RA4/T0	CKI pin CKI pin							
bit 3:	PSA: Prese 1 = Presca 0 = Presca	caler Assigr ler is assigr ler is assigr	nment bit ned to the WDT ned to the Timer() module								
bit 2-0:	PS2:PS0:	Prescaler R	ate Select bits									
	Bit Value	TMR0 Rate	WDT Rate									
	000 001 010 011 100 101 110 111	1 : 2 1 : 4 1 : 8 1 : 16 1 : 32 1 : 64 1 : 128 1 : 256	1 : 1 1 : 2 1 : 4 1 : 8 1 : 16 1 : 32 1 : 64 1 : 128									

Note: To achieve a 1:1 prescaler assignment for the TMR0 register, assign the prescaler to the Watchdog Timer by setting bit PSA (OPTION<3>).

5.0 I/O PORTS

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Some pins for these I/O ports are multiplexed with an alternate function for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Registers

PORTA is a 5-bit latch.

The RA4/T0CKI pin is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a TRISA register bit puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin(s).

Reading the PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch.

Pin RA4 is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin.

Other PORTA pins are multiplexed with analog inputs and analog VREF input. The operation of each pin is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register1).

Note:	On a Power-on Reset, these pins are con-
	figured as analog inputs and read as '0'.

The TRISA register controls the direction of the RA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 5-1: INITIALIZING PORTA



FIGURE 5-1: BLOCK DIAGRAM OF RA3:RA0 PINS



FIGURE 5-2: BLOCK DIAGRAM OF RA4/ T0CKI PIN



5.3 I/O Programming Considerations

5.3.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (e.g., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched to an output, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-3 shows the effect of two sequential readmodify-write instructions on an I/O port.

EXAMPLE 5-3: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

;Initial PORT settings: PORTB<7:4> Inputs
; PORTB<3:0> Outputs
;PORTB<7:6> have external pull-ups and are
;not connected to other circuitry
;

;					PORT	latch	PORT 1	pins
;								
	BCF	PORTB,	7	;	01pp	pppp	11pp	pppp
	BCF	PORTB,	б	;	10pp	pppp	11pp	pppp
	BSF	STATUS,	RP0	;				
	BCF	TRISB,	7	;	10pp	pppp	11pp	pppp
	BCF	TRISB,	б	;	10pp	pppp	10pp	pppp

;Note that the user may have expected the ;pin values to be 00pp ppp. The 2nd BCF ;caused RB7 to be latched as the pin value ;(high).

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

5.3.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-6). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

FIGURE 5-6: SUCCESSIVE I/O OPERATION



TABLE 7-3: REGISTERS/BITS ASSOCIATED WITH A/D, PIC16C710/71/711

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh	INTCON	GIE	ADIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
89h	ADRES	A/D Res	sult Regist	ter						xxxx xxxx	uuuu uuuu
08h	ADCON0	ADCS1	ADCS0	_	CHS1	CHS0	GO/DONE	ADIF	ADON	00-0 0000	00-0 0000
88h	ADCON1	—	_	_			_	PCFG1	PCFG0	00	00
05h	PORTA	_	_	_	RA4	RA3	RA2	RA1	RA0	x 0000	u 0000
85h	TRISA	_	_	_	PORTA Data Direction Register					1 1111	1 1111

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used for A/D conversion.

TABLE 7-4: REGISTERS/BITS ASSOCIATED WITH A/D, PIC16C715

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh/8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	—	ADIF	—	—	-	—	—	—	-0	-0
8Ch	PIE1		ADIE	_	—	-	—	—	—	-0	-0
1Eh	ADRES	A/D Re	sult Regis	ster	-					XXXX XXXX	uuuu uuuu
1Fh	ADCON 0	ADCS 1	ADCS 0	CHS2	CHS1	CHS0	GO/ DONE	-	ADON	0000 00-0	0000 00-0
9Fh	ADCON 1	—	—	—	—	-	—	PCFG1	PCFG0	00	00
05h	PORTA	_	_	—	RA4	RA3	RA2	RA1	RA0	x 0000	u 0000
85h	TRISA	_	_	_	TRISA4	TRISA 3	TRISA2	TRISA1	TRISA0	1 1111	1 1111

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used for A/D conversion.

8.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 8-6 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 8-6: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT



Figure 8-7 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 8-7: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



8.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 8-8 shows how the R/C combination is connected to the PIC16CXX. For Rext values below 2.2 k Ω , the oscillator operation may become unstable, or stop completely. For very high Rext values (e.g. 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep Rext between 3 k Ω and 100 k Ω .

Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See characterization data for desired device for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See characterization data for desired device for variation of oscillator frequency due to VDD for given Rext/ Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-2 for waveform).



FIGURE 8-8: RC OSCILLATOR MODE

Register	Power-on Reset, Brown-out Reset ⁽⁵⁾	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	XXXX XXXX	uuuu uuuu	นนนน นนนน
INDF	N/A	N/A	N/A
TMR0	xxxx xxxx	นนนน นนนน	นนนน นนนน
PCL	0000h	0000h	PC + 1 (2)
STATUS	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	xxxx xxxx	นนนน นนนน	นนนน นนนน
PORTA	x 0000	u 0000	u uuuu
PORTB	xxxx xxxx	<u>uuuu</u> uuuu	นนนน นนนน
PCLATH	0 0000	0 0000	u uuuu
INTCON	0000 000x	0000 000u	uuuu uuuu (1)
ADRES	XXXX XXXX	นนนน นนนน	นนนน นนนน
ADCON0	00-0 0000	00-0 0000	uu-u uuuu
OPTION	1111 1111	1111 1111	นนนน นนนน
TRISA	1 1111	1 1111	u uuuu
TRISB	1111 1111	1111 1111	นนนน นนนน
PCON ⁽⁴⁾	Ou		uu
ADCON1	00	00	uu

TABLE 8-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS, PIC16C710/71/711

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition Note 1: One or more bits in INTCON will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 8-10 for reset value for specific condition.

4: The PCON register is not implemented on the PIC16C71.

5: Brown-out reset is not implemented on the PIC16C71.



FIGURE 8-12: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2



FIGURE 8-13: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)



FIGURE 8-14: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - R < 40 kΩ is recommended to make sure that voltage drop across R does not violate the device's electrical specification.
 - 3: $R1 = 100\Omega$ to $1 k\Omega$ will limit any current flowing into \overline{MCLR} from external capacitor C in the event of \overline{MCLR}/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

FIGURE 8-15: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- 2: Internal brown-out detection on the PIC16C710/711/715 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistor.

FIGURE 8-16: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



Note 1: This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

- 2: Internal brown-out detection on the PIC16C710/711/715 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistor.

8.5.1 INT INTERRUPT

External interrupt on RB0/INT pin is edge triggered: either rising if bit INTEDG (OPTION<6>) is set, or falling, if the INTEDG bit is clear. When a valid edge appears on the RB0/INT pin, flag bit INTF (INTCON<1>) is set. This interrupt can be disabled by clearing enable bit INTE (INTCON<4>). Flag bit INTF must be cleared in software in the interrupt service routine before re-enabling this interrupt. The INT interrupt can wake-up the processor from SLEEP, if bit INTE was set prior to going into SLEEP. The status of global interrupt enable bit GIE decides whether or not the processor branches to the interrupt vector following wake-up. See Section 8.8 for details on SLEEP mode.

8.5.2 TMR0 INTERRUPT

An overflow (FFh \rightarrow 00h) in the TMR0 register will set flag bit T0IF (INTCON<2>). The interrupt can be enabled/disabled by setting/clearing enable bit T0IE (INTCON<5>). (Section 6.0)

8.5.3 PORTB INTCON CHANGE

An input change on PORTB<7:4> sets flag bit RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit RBIE (INTCON<4>). (Section 5.2)

For the PIC16C71 Note: if a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not get set.

	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
OSC1 /					
CLKOUT ③	(4)			/	
INT pin		1	1 1 1 1		1 1 1 1 1 1 1 1
INTF flag (INTCON<1>)			Interrupt Latency (2)		
GIE bit (INTCON<7>)					
INSTRUCTION	FLOW		, , , , , , , , , , , , , , , , , , , ,		· · · · · · · · · · · · · · · · · · ·
PC	PC	PC+1	PC+1	X 0004h	X 0005h
Instruction (fetched	Inst (PC)	Inst (PC+1)	_	Inst (0004h)	Inst (0005h)
Instruction {	Inst (PC-1)	Inst (PC)	Dummy Cycle	Dummy Cycle	Inst (0004h)

FIGURE 8-19: INT PIN INTERRUPT TIMING

Note 1: INTF flag is sampled here (every Q1).

2: Interrupt latency = 3-4 Tcy where Tcy = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.

3: CLKOUT is available only in RC oscillator mode. 4: For minimum width of INT pulse, refer to AC specs.

5: INTF is enabled to be set anytime during the Q4-Q1 cycles.

SUBWF	Subtract	W from f		
Syntax:	[label]	SUBWF	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 122 \\ d \in \ [0,1] \end{array}$	7		
Operation:	(f) - (W) –	→ (dest)		
Status Affected:	C, DC, Z			
Encoding:	00	0010	dfff	ffff
Description:	Subtract (2 ister from r stored in th result is sto	's compler egister 'f'. I le W regist pred back i	nent metho f 'd' is 0 the er. If 'd' is 1 n register 'f	d) W reg- e result is the
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to dest
Example 1:	SUBWF	reg1,1		
	Before Ins	struction		
	REG1	=	3	
	VV C	=	2 ?	
	Z	=	?	
	After Instr	uction		
	REG1	=	1	
	C	=	∠ 1; result is	positive
	Z	=	0	•
Example 2:	Before Ins	struction		
	REG1	=	2	
	W C	=	2 ?	
	Z	=	?	
	After Instr	uction		
	REG1	=	0	
	W C	=	2 1: result is	zero
	Z	=	1	2010
Example 3:	Before Ins	struction		
	REG1	=	1	
	W C	=	2	
	Z	=	?	
	After Instr	uction		
	REG1	=	0xFF	
	W C	=	2 0: result is	negative
	7	_	0	

SWAPF	Swap Ni	bbles in	f					
Syntax:	[label]	SWAPF 1	i,d					
Operands:	$0 \le f \le 127$ $d \in [0,1]$							
Operation:	$(f < 3:0 >) \rightarrow (dest < 7:4 >),$ $(f < 7:4 >) \rightarrow (dest < 3:0 >)$							
Status Affected:	None							
Encoding:	00	1110	dfff	ffff				
Description:	The upper and lower nibbles of regis- ter 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Process data	Write to dest				
Example	SWAPF	REG,	0					
	Before In	struction						
		REG1	= 0x	A5				
	After Inst	ruction						
		REG1 W	= 0x = 0x	A5 5A				

TRIS	Load TR	IS Regis	ster				
Syntax:	[<i>label</i>]	TRIS	f				
Operands:	$5 \leq f \leq 7$						
Operation:	$(W) \rightarrow TF$	RIS regis	ster f;				
Status Affected:	None						
Encoding:	00	0000	0110	Offf			
Description:	The instruction is supported for code compatibility with the PIC16C5X prod- ucts. Since TRIS registers are read- able and writable, the user can directly address them.						
Words:	1						
Cycles:	1						
Example							
	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.						

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TABLE 12-1: RC OSCILLATOR FREQUENCIES

Cevt	Rovt	Average	
UEAL	Next	Fosc @ 5V, 2	25°C
22 pF	5k	4.12 MHz	± 1.4%
	10k	2.35 MHz	± 1.4%
	100k	268 kHz	± 1.1%
100 pF	3.3k	1.80 MHz	± 1.0%
	5k	1.27 MHz	± 1.0%
	10k	688 kHz	± 1.2%
	100k	77.2 kHz	± 1.0%
300 pF	3.3k	707 kHz	± 1.4%
	5k	501 kHz	± 1.2%
	10k	269 kHz	± 1.6%
	100k	28.3 kHz	±1.1%

The percentage variation indicated here is part to part variation due to normal process distribution. The variation indicated is ± 3 standard deviation from average value for VDD = 5V.

FIGURE 12-19: TRANSCONDUCTANCE(gm) OF HS OSCILLATOR vs. VDD



FIGURE 12-20: TRANSCONDUCTANCE(gm) OF LP OSCILLATOR vs. VDD



FIGURE 12-21: TRANSCONDUCTANCE(gm) OF XT OSCILLATOR vs. VDD



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FIGURE 12-23: TYPICAL XTAL STARTUP TIME vs. VDD (HS MODE, 25°C)



FIGURE 12-24: TYPICAL XTAL STARTUP TIME vs. VDD (XT MODE, 25°C)



TABLE 12-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATORS

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
Crystals Used			
32 kHz	Epson C-001R32.768K-A		± 20 PPM
200 kHz	STD XTL 200.000KHz		± 20 PPM
1 MHz	ECS ECS-10-13-1		± 50 PPM
4 MHz	ECS ECS-40-20-1		± 50 PPM
8 MHz	EPSON CA-301 8.000M-C		± 30 PPM
20 MHz	EPSON CA-301 20.000M-C		± 30 PPM

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FIGURE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, AND POWER-UP TIMER TIMING





TABLE 13-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
No.	$ \setminus \lor $	$\langle \frown \rangle$					
30	TmcL	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	< Tost	Oscillation Start-up Timer Period	—	1024Tosc		-	Tosc = OSC1 period
33*	Tpwrt	Power up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tioz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μs	
35	TBOR	Brown-out Reset pulse width	100	—		μs	$VDD \le BVDD (D005)$
36	TPER	Parity Error Reset		TBD	_	μs	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

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FIGURE 16-12: TYPICAL IDD vs. FREQ (EXT CLOCK, 25°C)



Data based on matrix samples. See first page of this section for details.

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FIGURE 16-14: MAXIMUM IDD vs. FREQ WITH A/D OFF (EXT CLOCK, -55° TO +125°C)



APPENDIX A:

The following are the list of modifications over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14-bits. This allows larger page sizes both in program memory (1K now as opposed to 512 before) and register file (68 bytes now versus 32 bytes before).
- 2. A PC high latch register (PCLATH) is added to handle program memory paging. Bits PA2, PA1, PA0 are removed from STATUS register.
- 3. Data memory paging is redefined slightly. STATUS register is modified.
- Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.
 Two instructions TRIS and OPTION are being phased out although they are kept for compati-bility with PIC16C5X.
- 5. OPTION and TRIS registers are made addressable.
- 6. Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. Reset vector is changed to 0000h.
- Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
- 10. Wake up from SLEEP through interrupt is added.
- 11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt on change feature.
- 13. T0CKI pin is also a port pin (RA4) now.
- 14. FSR is made a full eight bit register.
- "In-circuit serial programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, Vss, MCLR/VPP, RB6 (clock) and RB7 (data in/out).
- PCON status register is added with a Power-on Reset status bit (POR).
- 17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.
- Brown-out protection circuitry has been added. Controlled by configuration word bit BODEN. Brown-out reset ensures the device is placed in a reset condition if VDD dips below a fixed setpoint.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

- 1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to 0000h.

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